08-22-2007

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Docket No.: 075905-0043 103438645 thed documents or the new address(es) below. To the Director of the U.S. Patent ar. 2. Name and address of receiving party(ies) 1. Name of Conveying Party(ies) HITACHI HIGH-TECHNOLOGIES Hiroshi NAKAMURA, Tsukasa SHISHIKA, Yasushi TERUI, Name: CORPORATION Takuya SAEKI Internal Address: Additional name(s) of conveying party(ies) attached? Yes No 3. Nature of Conveyance/Execution Date(s) Address: 1-24-14, Nishi Shinbashi, Minato-ku, Execution Date(s): August 6, 2007, August 7, 2007, August 6, Tokyo, JAPAN 2007, August 6, 2007 (respectively) Merger ☐ Change of Name Security Agreement ☐ Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Additional name(s) & address(es) attached? Yes No Other This document is being filed together with a new application 4. Application or patent number(s): A. Patent Application No(s). B. Patent No(s). Additional numbers attached? Yes No 5. Name and address to whom correspondence concerning 6. Total number of applications and patents document should be mailed: involved: Name: MCDERMOTT WILL & EMERY LLP \$40.00 7. Total fee (37 CFR 1.21(h) & 3.41) Internal Address: Authorized to be charged by credit card Authorized to be charged to deposit account ☐ Enclosed Street Address: 600 13th Street, N.W. None required (government interest not affecting title) 20005-3096 City: Washington D. C. Zip: State: Phone Number: 202.756.8000 8. Payment Information: Fax Number: 202.756.8087 Email Address: Credit Card Last 4 Numbers a. 08/21/2007 DBYRNE 700000177 500417 11889264 **Expiration Date** Deposit Account Number 500417 01 FC:8021 Authorized User Name 9. Signature. Keith E. George, 34,111 August 10, 2007 Name and Registration No. of Person Signing Signature Date Total number of pages including cover sheet, attachments and documents:

> PATENT REEL: 019742 FRAME: 0391

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable Hitachi High-Technologies Corporation, consideration paid to me citizen of Japan by a corporation organized under the laws of Japan,

located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

RECORDED: 08/10/2007

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Kiroshi Nakamona	8/6/2007
2) Jouleana Shishika	8-17/2007
3) Yasushi Terut	8/6/2007
4) Sacho	8/6/2007
5)	
6)	
7)	
8)	
9)	
10)	

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Date Signed